

50074885
02/12/2002
11/13/02

PATENT NUMBER and
ISSUE DATE

U.S. UTILITY Patent Application

APPL NUM 10074885	FILING DATE 02/12/2002	CLASS 257	SUBCLASS	GAU 2811	EXAMINER
**APPLICANTS: Zeighami Roy, Belady Christian					
**CONTINUING DATA VERIFIED:					
** FOREIGN APPLICATIONS VERIFIED:					
PG-PUB <input type="checkbox"/>		DO NOT PUBLISH <input type="checkbox"/>		RESCIND <input type="checkbox"/>	
Foreign priority claimed <input type="checkbox"/> yes <input checked="" type="checkbox"/> no				ATTORNEY DOCKET NO	
35 USC 119 conditions met <input type="checkbox"/> yes <input checked="" type="checkbox"/> no				10014777-1	
Verified and Acknowledged Examiners's initials <i>Gu</i>					
TITLE : Loop thermosyphon using microchannel etched semiconductor die as evaporator					

NOTICE OF ALLOWANCE MAILED		CLAIMS ALLOWED	
		Total Claims	Print Claim for O.G.
ISSUE FEE		DRAWING	
Amount Due	Date Paid	Sheets Drwg.	Figs.Drwg.
		3	4
<input type="checkbox"/> TERMINAL DISCLAIMER		Print Fig.	
		Application Examiner	
		PREPARED FOR ISSUE	
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